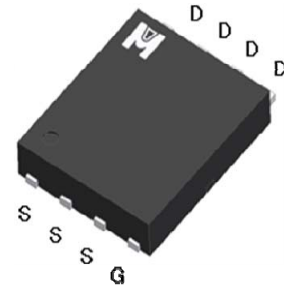


N-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

$BV_{DSS}$	40V
$R_{DS(on)} (MAX.)$	1.6m $\Omega$
$I_D$	100A



UIS, Rg 100% Tested

Pb-Free Lead Plating & Halogen Free



ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$  Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNIT
Gate-Source Voltage		$V_{GS}$	$\pm 20$	V
Continuous Drain Current <sup>1</sup>	$T_C = 25^\circ\text{C}$	$I_D$	100	A
	$T_C = 100^\circ\text{C}$		100	
Pulsed Drain Current <sup>2</sup>		$I_{DM}$	400	
Avalanche Current		$I_{AS}$	85	
Avalanche Energy	$L = 0.1\text{mH}, I_D = 85\text{A}, R_G = 25\Omega$	$E_{AS}$	361	mJ
Repetitive Avalanche Energy <sup>3</sup>	$L = 0.05\text{mH}$	$E_{AR}$	180	
Power Dissipation	$T_C = 25^\circ\text{C}$	$P_D$	65	W
	$T_C = 100^\circ\text{C}$		26	
Operating Junction & Storage Temperature Range		$T_{j}, T_{stg}$	-55 to 150	$^\circ\text{C}$

100% UIS testing in condition of  $V_D = 30\text{V}, L = 0.1\text{mH}, V_G = 10\text{V}, I_L = 50\text{A}$ , Rated  $V_{DS} = 40\text{V}$  N-CH

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNIT
Junction-to-Case	$R_{\theta JC}$		1.9	$^\circ\text{C} / \text{W}$
Junction-to-Ambient <sup>4</sup>	$R_{\theta JA}$		50	

<sup>1</sup> Package Limited.

<sup>2</sup> Pulse width limited by maximum junction temperature.

<sup>3</sup> Duty cycle  $\leq 1\%$

<sup>4</sup>  $50^\circ\text{C} / \text{W}$  when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.



ELECTRICAL CHARACTERISTICS ( $T_J = 25\text{ }^\circ\text{C}$ , Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
<b>STATIC</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	40			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.0	2.0	3.0	
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0V, V_{GS} = \pm 20V$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 32V, V_{GS} = 0V$			1	$\mu A$
		$V_{DS} = 30V, V_{GS} = 0V, T_J = 125\text{ }^\circ\text{C}$			25	
On-State Drain Current <sup>1</sup>	$I_{D(ON)}$	$V_{DS} = 10V, V_{GS} = 10V$	100			A
Drain-Source On-State Resistance <sup>1</sup>	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 50A$		1.4	1.6	m $\Omega$
		$V_{GS} = 4.5V, I_D = 50A$		2.2	2.5	
Forward Transconductance <sup>1</sup>	$g_{fs}$	$V_{DS} = 5V, I_D = 50A$		65		S
<b>DYNAMIC</b>						
Input Capacitance	$C_{iss}$	$V_{GS} = 0V, V_{DS} = 20V, f = 1MHz$		6078		pF
Output Capacitance	$C_{oss}$			1101		
Reverse Transfer Capacitance	$C_{rss}$			250		
Gate Resistance	$R_g$	$V_{GS} = 15mV, V_{DS} = 0V, f = 1MHz$		2.0		$\Omega$
Total Gate Charge <sup>1,2</sup>	$Q_g(V_{GS}=10V)$	$V_{DS} = 20V, V_{GS} = 10V, I_D = 50A$		82.9		nC
	$Q_g(V_{GS}=4.5V)$			34.3		
Gate-Source Charge <sup>1,2</sup>	$Q_{gs}$			27.2		
Gate-Drain Charge <sup>1,2</sup>	$Q_{gd}$			4.3		
Turn-On Delay Time <sup>1,2</sup>	$t_{d(on)}$		$V_{DS} = 20V, I_D = 1A, V_{GS} = 10V, R_{GS} = 6\Omega$		15	
Rise Time <sup>1,2</sup>	$t_r$			10		
Turn-Off Delay Time <sup>1,2</sup>	$t_{d(off)}$			60		
Fall Time <sup>1,2</sup>	$t_f$			15		
<b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (<math>T_C = 25\text{ }^\circ\text{C}</math>)</b>						
Continuous Current	$I_S$				100	A
Pulsed Current <sup>3</sup>	$I_{SM}$				400	
Forward Voltage <sup>1</sup>	$V_{SD}$	$I_F = 50A, V_{GS} = 0V$			1.2	V
Reverse Recovery Time	$t_{rr}$	$I_F = 50A, di_F/dt = 100A / \mu S$		90		nS
Reverse Recovery Charge	$Q_{rr}$				125	

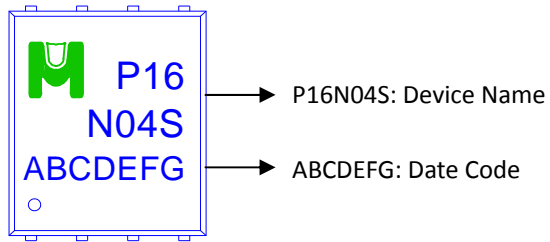
<sup>1</sup>Pulse test : Pulse Width  $\leq 300 \mu\text{sec}$ , Duty Cycle  $\leq 2\%$ .

<sup>2</sup>Independent of operating temperature.

<sup>3</sup>Pulse width limited by maximum junction temperature.

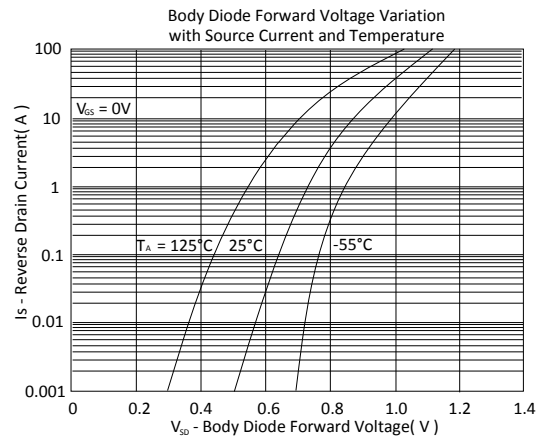
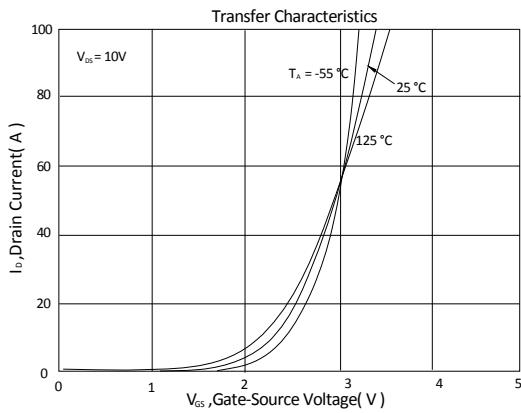
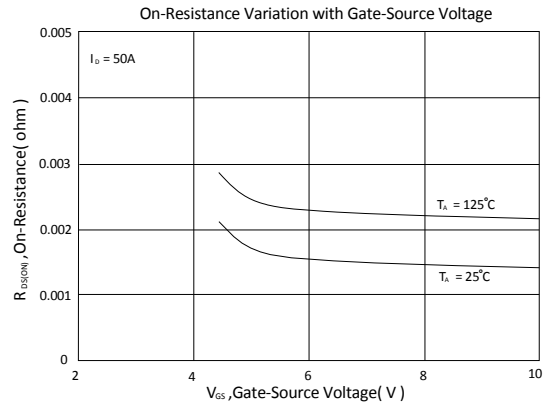
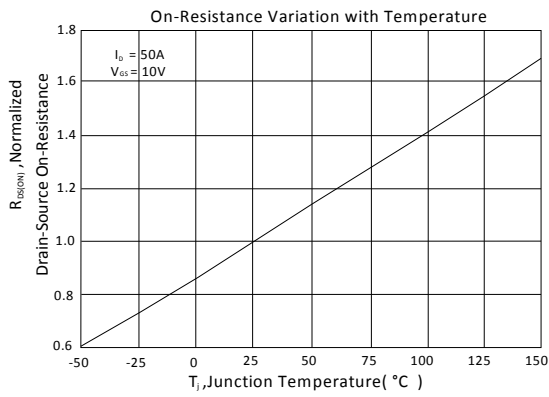
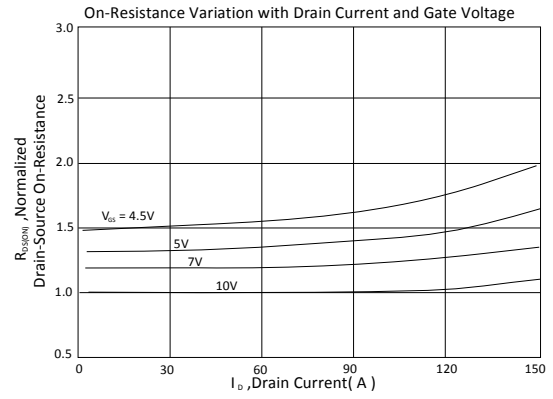
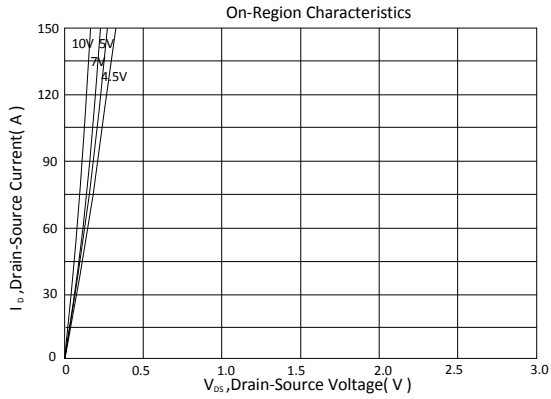
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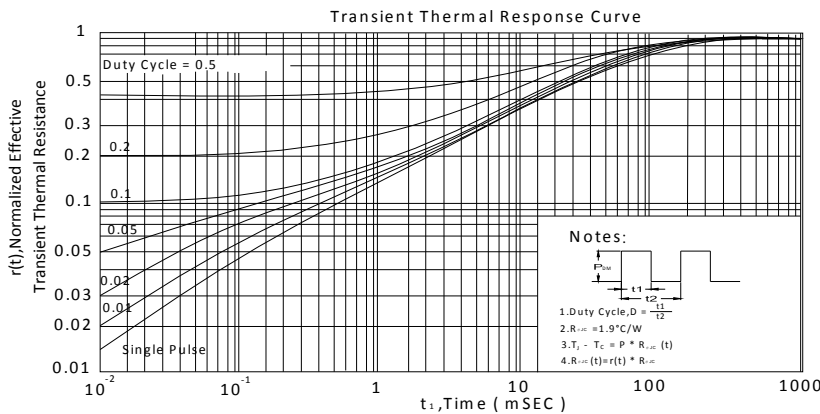
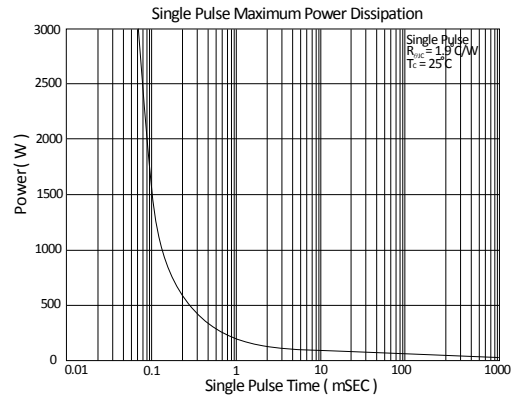
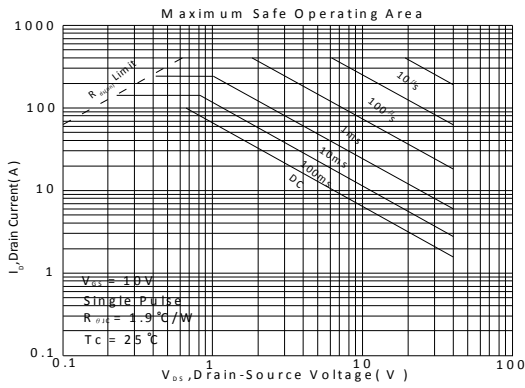
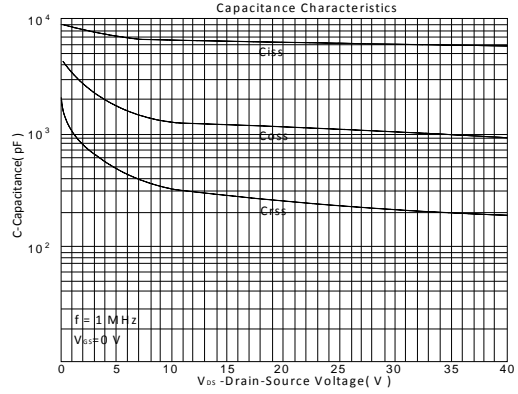
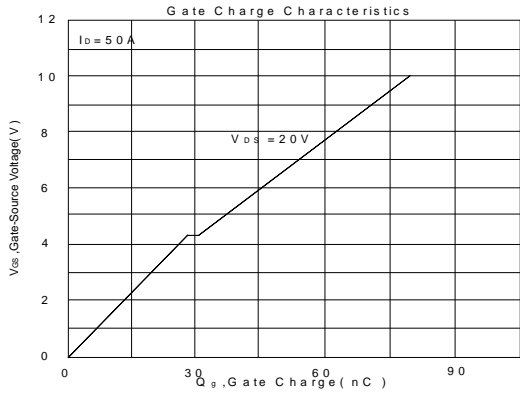
Device Name: EMP16N04HS for EDFN 5 x 6





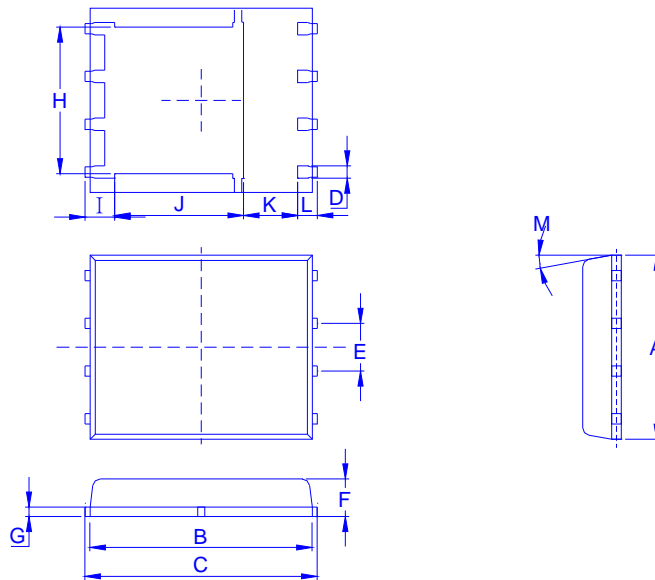
TYPICAL CHARACTERISTICS







Outline Drawing



Dimension in mm

Dimension	A	B	C	D	E	F	G	H	I	J	K	L	M
Min.	4.80	5.50	5.90	0.3		0.85	0.15	3.67	0.41	3.00	0.94	0.45	0°
Typ.					1.27								
Max.	5.30	5.90	6.15	0.51		1.20	0.30	4.54	0.85	3.92	1.7	0.71	12°

Recommended minimum pads

